PRELIMINARY


## Features

- DI Monolithic High Voltage Process
- Compatible with Worldwide PBX and CO Performance Requirements
- Controlled Supply of Battery Feed Current with Programmable Current Limit
- Operates with 5V Positive Supply ( $\mathrm{V}_{\mathrm{B}_{+}}$)
- Internal Ring Relay Driver and a Utility Relay Driver
- High Impedance Mode for Subscriber Loop
- High Temperature Alarm Output
- Low Power Consumption During Standby Functions
- Switch Hook, Ground Key, and Ring Trip Detection
- Selective Power Denial to Subscriber
- Voice Path Active During Power Denial
- On Chip Op-Amp for 2 Wire Impedance Matching


## Applications

- Solid State Line Interface Circuit for PBX or Central Office Systems, Digital Loop Carrier Systems
- Hotel/Motel Switching Systems
- Direct Inward Dialing (DID) Trunks
- Voice Messaging PBX's
- High Voltage 2W/4W, 4W/2W Hybrid


## Ordering Information

| PART NUMBER | TEMP. RANGE | PACKAGE |
| :--- | :---: | :--- |
| HC1-5509A1-5 | $0^{\circ}$ to $+75^{\circ} \mathrm{C}$ | 28 Lead Ceramic DIP |
| HC1-5509A1-9 | $-40^{\circ}$ to $+85^{\circ} \mathrm{C}$ | 28 Lead Ceramic DIP |
| HC3-5509A1-5 | $0^{\circ}$ to $+75^{\circ} \mathrm{C}$ | 28 Lead Plastic DIP |
| HC3-5509A1-9 | $-40^{\circ}$ to $+85^{\circ} \mathrm{C}$ | 28 Lead Plastic DIP |
| HC4P5509A1-5 | $0^{\circ}$ to $+75^{\circ} \mathrm{C}$ | 44 Lead PLCC |
| HC4P5509A1-9 | $-40^{\circ}$ to $+85^{\circ} \mathrm{C}$ | 44 Lead PLCC |
| HC9P5509A1-5 | $0^{\circ}$ to $+75^{\circ} \mathrm{C}$ | 28 Lead SOIC |

## Description

The HC-5509A1 telephone Subscriber Line Interface Circuit integrates most of the BORSCHT functions on a monolithic IC. The device is manufactured in a Dielectric Isolation (DI) process and is designed for use as a high voltage interface between the traditional telephone subscriber pair (Tip and Ring) and the low voltage filtering and coding/decoding functions of the line card. Together with a secondary protection diode bridge and "feed" resistors, the device will withstand 1000 V lightning induced surges, in plastic packages. The SLIC also maintains specified transmission performance in the presence of externally induced longitudinal currents. The BORSCHT functions that the SLIC provides are:

- Battery Feed with Subscriber Loop Current Limiting
- Overvoltage Protection
- Ring Relay Driver
- Supervisory Signaling Functions
- Hybrid Functions (with External Op-Amp)
- Test (or Battery Reversal) Relay Driver

In addition, the SLIC provides selective denial of power to subscriber loops, a programmable subscriber loop current limit from 20 to 60 mA , a thermal shutdown with an alarm output and line fault protection. Switch hook detection, ring trip detection and ground key detection functions are also incorporated in the SLIC device.

The HC-5509A1 SLIC is ideally suited for line card designs in PBX and CO systems, replacing traditional transformer solutions.

## Pinouts



HC-5509A1 (PLCC) TOP VIEW


## Specifications HC-5509A1



## Operating Conditions

Operating Temperature Range
HC-5509A1-5. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $0^{\circ} \mathrm{C}$ to $+75^{\circ} \mathrm{C}$
HC-5509A1-9. . . . . . . . . . . . . . . . . . . . . . . . . . . . . $40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature Range . . . . . . . . . . . . . . . . . . $65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Relay Drivers. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . +5 V to +12 V
Positive Power Supply ( $\mathrm{V}_{\mathrm{B}_{+}}$) . . . . . . . . . . . . . . . . . . . . . . . . $+5 \mathrm{~V} \pm 5 \%$
Negative Power Supply ( $\mathrm{V}_{\mathrm{B}}$ ) . . . . . . . . . . . . . . . . . . . . . 42 V to -58 V
Loop Resistance ( $\mathrm{R}_{\mathrm{L}}$ ) . . . . . . . . . . . . . . . . . $200 \Omega$ to $1750 \Omega$ (Note 2)

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

| Electrical Specifications | Unless Otherwise Specified, Typical Parameters are at $T_{A}=+25^{\circ} \mathrm{C}$, Min-Max Parameters are over |
| :--- | :--- |
|  | Operating Temperature Range, $\mathrm{V}_{B-}=-48 \mathrm{~V}, \mathrm{~V}_{B_{+}}=+5 \mathrm{~V}, \mathrm{AG}=\mathrm{DG}=\mathrm{BG}=0 \mathrm{~V} . \mathrm{All} \mathrm{A} . \mathrm{C}$. Parameters are | specified at $600 \Omega 2$-Wire terminating impedance.


| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: |
| A.C. TRANSMISSION PARAMETERS |  |  |  |  |  |
| RX Input Impedance | 300 Hz to 3.4 kHz (Note 3) | - | 100 | - | k $\Omega$ |
| TX Output Impedance | 300 Hz to 3.4 kHz (Note 3) | - | - | 20 | $\Omega$ |
| 4W Input Overload Level | 300 Hz to $3.4 \mathrm{kHz} \mathrm{R}_{\mathrm{L}}=1200 \Omega$, $600 \Omega$ Reference | +1.5 | - | - | $\mathrm{V}_{\text {PEAK }}$ |
| 2W Return Loss | Matched for $600 \Omega$ (Note 3) |  |  |  |  |
| SRL LO |  | 26 | 35 | - | dB |
| ERL |  | 30 | 40 | - | dB |
| SRL HI |  | 30 | 40 | - | dB |
| 2W Longitudinal to Metallic Balance Off Hook | Per ANSI/IEEE STD 455-1976 (Note 3) 300 Hz to 3400 Hz | 58 | 63 | - | dB |
| 4W Longitudinal Balance Off Hook | 300 Hz to 3400 Hz (Note 3) | 50 | 55 | - | dB |
| Low Frequency Longitudinal Balance | R.E.A. Test Circuit | - | - | -67 | dBmp |
|  | $\mathrm{I}_{\text {LINE }}=40 \mathrm{~mA} \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ (Note 3) | - | - | 23 | dBrnC |
| Longitudinal Current Capability | $\mathrm{I}_{\text {LINE }}=40 \mathrm{~mA} \mathrm{~T} \mathrm{~A}_{\text {A }}=+25^{\circ} \mathrm{C}($ Note 3) | - | - | 30 | mArms |
| Insertion Loss | OdBm at 1kHz, Referenced $600 \Omega$ |  |  |  |  |
| 2W/4W |  | - | $\pm 0.05$ | $\pm 0.2$ | dB |
| 4W/2W |  | - | $\pm 0.05$ | $\pm 0.2$ | dB |
| 4W/4W |  | - | - | $\pm 0.12$ | dB |
| Frequency Response | 300 Hz to 3400 Hz (Note 3) Referenced to Absolute Level at $1 \mathrm{kHz}, 0 \mathrm{dBm}$ Referenced $600 \Omega$ | - | $\pm 0.02$ | $\pm 0.05$ | dB |
| Level Linearity <br> 2 W to 4 W and 4 W to 2 W | Referenced to-10dBm (Note 3) +3 to -40dBm | - | - | $\pm 0.05$ | dB |
|  | -40 to -50dBm | - | - | $\pm 0.1$ | dB |
|  | -50 to -55dBm | - | - | $\pm 0.3$ | dB |
| Absolute Delay | (Note 3) |  |  |  |  |

Specifications HC-5509A1

| Electrical Specifications | Unless Otherwise Specified, Typical Parameters are at $T_{A}=+25^{\circ} \mathrm{C}$, Min-Max Parameters are over Operating Temperature Range, $\mathrm{V}_{\mathrm{B}-}=-48 \mathrm{~V}, \mathrm{~V}_{\mathrm{B}_{+}}=+5 \mathrm{~V}, \mathrm{AG}=\mathrm{DG}=\mathrm{BG}=0 \mathrm{~V}$. All A.C. Parameters are specified at $600 \Omega 2$-Wire terminating impedance. (Continued) |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
| 2W/4W PARAMETER | TEST CONDITIONS <br> 300 Hz to 3400 Hz | MIN | TYP | MAX | UNITS |
|  |  | - | - | 1 | $\mu \mathrm{s}$ |
| 4W/2W | 300 Hz to 3400 Hz | - | - | 1 | $\mu \mathrm{s}$ |
| 4W/4W | 300 Hz to 3400 Hz | - | - | 1.5 | $\mu \mathrm{s}$ |
| Transhybrid Loss, THL | (Note 3) See Figure 1 | - | 40 | - | dB |
| Total Harmonic Distortion 2W/4W, 4W/2W, 4W/4W | Reference Level 0dBm at $600 \Omega$ 300 Hz to 3400 Hz (Note 3) | - | - | -52 | dB |
| Idle Channel Noise <br> 2 W and 4 W | (Note 3) <br> C-Message | - | - | 5 | dBrnC |
|  | Psophometric | - | - | -85 | dBmp |
|  | 3 kHz Flat | - | - | 15 | dBrn |
| Power Supply Rejection Ratio $V_{B+} \text { to } 2 W$ | (Note 3) <br> 30 Hz to $200 \mathrm{~Hz}, \mathrm{R}_{\mathrm{L}}=600 \Omega$ | 20 | 29 | - | dB |
| $\mathrm{V}_{\mathrm{B}+}$ to 4W |  | 20 | 29 | - | dB |
| $\mathrm{V}_{\mathrm{B} \text { - }}$ to 2 W |  | 20 | 29 | - | dB |
| $\mathrm{V}_{\mathrm{B} \text { - }}$ to 4W |  | 20 | 29 | - | dB |
| $\mathrm{V}_{\mathrm{B}_{+}}$to 4W | (Note 3) | 30 | - | - | dB |
| $\mathrm{V}_{\mathrm{B} \text { - }}$ to 2 W |  | 30 | - | - | dB |
| $\mathrm{V}_{\mathrm{B} \text { - }}$ to 4W |  | 20 | 25 | - | dB |
| $\mathrm{V}_{\mathrm{B} \text { - }}$ to 4W |  | 20 | 25 | - | dB |
| Ring Sync Pulse Width |  | 50 | - | 500 | $\mu \mathrm{s}$ |
| D.C. PARAMETERS |  |  |  |  |  |
| Loop Current Programming Limit Range |  | 20 | 40 | 60 | mA |
| Accuracy |  | 10 | - | - | \% |
| Loop Current During Power Denial | $R_{L}=200 \Omega$ | - | $\pm 3$ | $\pm 5$ | mA |
| Fault Currents <br> TIP to Ground |  | - | 30 | - | mA |
| RING to Ground |  | - | 60 | - | mA |
| TIP and RING to Ground |  | - | 90 | - | mA |
| Switch Hook Detection Threshold |  | - | 12 | 15 | mA |
| Ground Key Detection Threshold |  | 8 | 12 | 16 | mA |
| Thermal ALARM Output | Safe Operating Die Temperature Exceeded | 140 | - | 160 | ${ }^{\circ} \mathrm{C}$ |
| Ring Trip Comparator Threshold | See Typical Applications for more information | 9.5 | 13.5 | 17.5 | mA |
| Dial Pulse Distortion |  | - | 0.1 | 0.5 | ms |

Specifications HC-5509A1
Electrical Specifications Unless Otherwise Specified, Typical Parameters are at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, Min-Max Parameters are over Operating Temperature Range, $\mathrm{V}_{\mathrm{B}-}=-48 \mathrm{~V}, \mathrm{~V}_{\mathrm{B}_{+}}=+5 \mathrm{~V}, \mathrm{AG}=\mathrm{DG}=\mathrm{BG}=0 \mathrm{~V}$. All A.C. Parameters are specified at $600 \Omega 2$-Wire terminating impedance. (Continued)

| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Relay Driver Outputs On Voltage $\mathrm{V}_{\mathrm{OL}}$ | $\mathrm{I}_{\mathrm{OL}}(\overline{\mathrm{PR}})=60 \mathrm{~mA}, \mathrm{I}_{\mathrm{OL}}(\overline{\mathrm{RD}})=30 \mathrm{~mA}$ | - | 0.2 | 0.5 | V |
| Off Leakage Current | $\mathrm{V}_{\mathrm{OH}}=13.2 \mathrm{~V}$ | - | $\pm 10$ | $\pm 100$ | $\mu \mathrm{A}$ |
| TTL/CMOS Logic Inputs (F0, F1, RS, $\overline{\text { TEST }}$, PRI) <br> Logic '0' $\mathrm{V}_{\text {IL }}$ |  | - | - | 0.8 | V |
| Logic '1' $\mathrm{V}_{\mathrm{IH}}$ |  | 2.0 | - | 5.5 | V |
| Input Current (F0, F1, RS, $\overline{\text { TEST, PRI) }}$ | $0 \mathrm{~V} \leq \mathrm{V}_{\mathrm{IN}} \leq 5 \mathrm{~V}$ | - | - | $\pm 100$ | $\mu \mathrm{A}$ |
| Logic Outputs Logic '0' $V_{\text {OL }}$ | $\mathrm{I}_{\text {LOAD }}=800 \mu \mathrm{~A}$ | - | 0.1 | 0.5 | V |
| Logic '1' $\mathrm{V}_{\mathrm{OH}}$ | $\mathrm{I}_{\text {LOAD }}=40 \mu \mathrm{~A}$ | 2.7 | - | - | V |
| Power Dissipation On Hook | Relay Drivers Off | - | 200 | - | mW |
| $\mathrm{I}_{\mathrm{B}+}$ | $\mathrm{V}_{\mathrm{B}_{+}}=+5.25 \mathrm{~V}, \mathrm{~V}_{\mathrm{B}-}=-58 \mathrm{~V}, \mathrm{R}_{\text {LOOP }}=\infty$ | - | - | 6 | mA |
| $\mathrm{I}_{\mathrm{B}}$ - | $\mathrm{V}_{\mathrm{B}_{+}}=+5.25 \mathrm{~V}, \mathrm{~V}_{\mathrm{B}^{-}}=-58 \mathrm{~V}, \mathrm{R}_{\text {LOOP }}=\infty$ | -6 | - | - | mA |
| UNCOMMITED OP AMP PARAMETERS |  |  |  |  |  |
| Input Offset Voltage |  | - | $\pm 5$ | - | mV |
| Input Offset Current |  | - | $\pm 10$ | - | nA |
| Differential Input Resistance | (Note 2) | - | 1 | - | $\mathrm{M} \Omega$ |
| Output Voltage Swing | $\mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega$ | - | $\pm 3$ | - | $\mathrm{V}_{\text {P-P }}$ |
| Small Signal GBW | (Note 2) | - | 1 | - | MHz |

## NOTES:

1. Absolute maximum ratings are limiting values, applied individually, beyond which the serviceability of the circuit may be impaired. Functional operability under any of these conditions is not necessarily implied.
2. May Be Extended to $1900 \Omega$ With Application Circuit.
3. These parameters are controlled by design or process parameters and are not directly tested. These parameters are characterized upon initial design release, upon design changes which would affect these characteristics, and at intervals to assure product quality and specification compliance.

## Pin Descriptions

| DIP/SOIC | PLCC | SYMBOL | DESCRIPTION |
| :---: | :---: | :---: | :--- |
| 1 | 2 | AG | Analog Ground - To be connected to zero potential. Serves as a reference for the transmit output <br> and receive input terminals. |
| 2 | 3 | VB+ | Positive Voltage Source - Most Positive Supply. |
| 3 | 4 | C1 | Capacitor \#C1 - An external capacitor to be connected between this terminal and analog ground. <br> Required for proper operation of the loop current limiting function. |
| 4 | 8 | F1 | Function Address \#1 - A TTL and CMOS compatible input used with F0 function address line to <br> externally select logic functions. The three selectable functions are mutually exclusive. See Truth <br> Table on page1. F1 should be toggled high after power is applied. |

## Pin Descriptions (Continued)

| DIP/SOIC | PLCC | SYMBOL | DESCRIPTION |
| :---: | :---: | :---: | :---: |
| 5 | 9 | F0 | Function Address \#0 - A TTL and CMOS compatible input used with F1 function address line to externally select logic functions. The three selectable functions are mutually exclusive. See Truth Table on page 1. |
| 6 | 10 | RS | Ring Synchronization Input - A TTL - compatible clock input. The clock is arranged such that a positive pulse ( $50-500 \mu \mathrm{~s}$ ) occurs on the zero crossing of the ring voltage source, as it appears at the RFS terminal. For Tip side injected systems, the RS pulse should occur on the negative going zero crossing and for Ring injected systems, on the positive going zero crossing. This ensures that the ring delay activates and deactivates when the instantaneous ring voltage is near zero. If synchronization is not required, the pin should be tied to +5 . |
| 7 | 11 | $\overline{\text { SHD }}$ | Switch Hook Detection - An active low LS TTL compatible logic output. A line supervisory output. |
| 8 | 12 | $\overline{\text { GKD }}$ | Ground Key Detection - An active low LS TTL compatible logic output. A line supervisory output. |
| 9 | 13 | TST | A TTL logic input. A low on this pin will set a latch and keep the SLIC in a power down mode until the proper F1, F0 state is set and will keep $\overline{\text { ALM }}$ low. See Truth Table on page 1. |
| 10 | 14 | $\overline{\text { ALM }}$ | A LS TTL compatible active low output which responds to the thermal detector circuit when a safe operating die temperature has been exceeded. When TST is forced low by an external control signal, $\overline{\text { ALM }}$ is latched low until the proper F1, F0 state and TST input is brought high. The $\overline{\mathrm{ALM}}$ can be tied directly to the TST pin to power down the part when a thermal fault is detected and then reset with F0, F1. See Truth Table on page 1. It is possible to ignore transient thermal overload conditions in the SLIC by delaying the response to the TST pin from the $\overline{\text { ALM }}$. Care must be exercised in attempting this as continued thermal overstress may reduced component life. |
| 11 | 18 | ILMT | Loop Current Limit - Voltage on this pin sets the short loop current limiting conditions using a resistive voltage divider. |
| 12 | 19 | OUT1 | The analog output of the spare operational amplifier. |
| 13 | 20 | -IN1 | The inverting analog input of the spare operational amplifier. |
| 14 | 22 | TIP | An analog input connected to the TIP (more positive) side of the subscriber loop through a feed resistor and ring relay contact. Functions with the RING terminal to receive voice signals from the telephone and for loop monitoring purpose. |
| 15 | 24 | RING | An analog input connected to the RING (more negative) side of the subscriber loop through a feed resistor. Functions with the TIP terminal to receive voice signals from the telephone and for loop monitoring purposes. |
| 16 | 25 | RFS | Ring Feed Sense - Senses RING side of the loop for Ground Key Detection. During Ring injected ringing the ring signal at this node is isolated from RF via the ring relay. For Tip injected ringing, the RF and RFS pins must be shorted. |
| 17 | 27 | VRX | Receive Input, Four Wire Side - A high impedance analog input. AC signals appearing at this input drive the Tip Feed and Ring Feed amplifiers differentially. |
| 18 | 31 | LAO | Longitudinal Amplifier Output - A low impedance output to be connected to C2 through a low pass filter. Output is proportional to the difference in $I_{\text {TIP }}$ and $I_{\text {RING }}$. |
| 19 | 32 | VTX | Transmit Output, Four Wire Side - A low impedance analog output which represents the differential voltage across TIP and RING. Transhybrid balancing must be performed beyond this output to completely implement two to four wire conversion. This output is referenced to analog ground. Since the D.C. level of this output varies with loop current, capacitive coupling to the next stage is necessary. |
| 20 | 33 | PRI | A TTL compatible input used to control $\overline{\mathrm{PR}}$. PRI active High $=\overline{\mathrm{PR}}$ active low. |
| 21 | 34 | $\overline{\mathrm{PR}}$ | An active low open collector output. Can be used to drive a Polarity Reversal Relay. |
| NA | 35 | DG | Digital Ground - To be connected to zero potential - serves as reference for all digital inputs and outputs on the SLIC. |
| 22 | 36 | BG | Battery Ground - Tube connected to zero potential. All loop current and some quiescent current flows into this terminal. |

## Pin Descriptions (Continued)

| DIP/SOIC | PLCC | SYMBOL | DESCRIPTION |
| :---: | :---: | :---: | :--- |
| 23 | 37 | $\overline{\text { RD }}$ | Ring Relay Driver - An active low open collector output. Used to drive a relay that switches ring- <br> ing signals onto the 2-Wire line. |
| 24 | 38 | VFB | Feedback input to the tip feed amplifier; may be used in conjunction with transmit output signal <br> and the spare op-amp to accommodate 2W line impedance matching. |
| 25 | 39 | TF2 | Tip Feed - A low impedance analog output connected to the TIP terminal through a feed resistor. <br> Functions with the RF terminal to provide loop current, and to feed voice signals to the telephone <br> set and to sink longitudinal currents. Must be tied to TF1. |
| NA | 40 | TF1 | Tie directly to TF2 in the PLCC application. |
| 26 | 41 | RF1 | Ring Feed - A low impedance analog output connected to the RING terminal through a feed re- <br> sistor. Functions with the TF terminal to provide loop current, feed voice signals to the telephone <br> set, and to sink longitudinal currents. Tie directly to RF2. |
| NA | 42 | RF2 | Tie directly to RF1 in the PLCC application. |
| 27 | 43 | VB- | The battery voltage source. The most negative supply. <br> 28 <br> 444 <br> C2 |
| $1,5,6,7$, <br> 15,16, <br> 17,21, <br> 23,26, <br> $28,29,30$ | Capacitor \#2 - An external capacitor to be connected between this terminal and ground. It pre- <br> vents false ring trip detection from occurring when longitudinal currents are induced onto the sub- <br> scriber loop from power lines and other noise sources. This capacitor should be nonpolarized. |  |  |

NOTE:

1. All grounds (AG, BG, DG) must be applied before $\mathrm{V}_{\mathrm{B}_{+}}$or $\mathrm{V}_{\mathrm{B} \text {. }}$ Failure to do so may result in premature failure of the part. If a user wishes to run separate grounds off a line card, the AG must be applied first.

Functional Diagram


High voltage surge conditions are as specified in Table 1.
The SLIC will withstand longitudinal currents up to a maximum or $30 \mathrm{mArms}, 15 \mathrm{mArms}$ per leg, without any performance degradation

TABLE 1.

| PARAMETER | TEST CONDITION | PERFORMANCE (MAX) | UNITS |
| :---: | :---: | :---: | :---: |
| Longitudinal Surge | $\begin{aligned} & 10 \mu \mathrm{~s} \text { Rise/ } \\ & 1000 \mu \mathrm{~s} \text { Fall } \end{aligned}$ | $\pm 1000$ (Plastic) | $\mathrm{V}_{\text {PEAK }}$ |
|  |  | $\pm 500$ (Ceramic) | $\mathrm{V}_{\text {PEAK }}$ |
| Metallic Surge | 10 $\mu \mathrm{s}$ Rise/ 1000 us Fall | $\pm 1000$ (Plastic) | $\mathrm{V}_{\text {PEAK }}$ |
|  |  | $\pm 500$ (Ceramic) | $V_{\text {PEAK }}$ |
| $\begin{array}{\|l} \hline \text { T/GND } \\ \text { R/GND } \end{array}$ | 10 $\mu \mathrm{s}$ Rise/ 1000 us Fall | $\pm 1000$ (Plastic) | $\mathrm{V}_{\text {PEAK }}$ |
|  |  | $\pm 500$ (Ceramic) | $\mathrm{V}_{\text {PEAK }}$ |
| $50 / 60 \mathrm{~Hz}$ Current <br> T/GND <br> R/GND | 11 Cycles <br> Limited to 10Arms | 700 (Plastic) | $\mathrm{V}_{\text {RMS }}$ |
|  |  | 350 (Ceramic) | $\mathrm{V}_{\text {RMS }}$ |




NOTE: PRI is an independent switch driven by TTL input lev-

## Applications Diagram



FIGURE 1. TYPICAL LINE CIRCUIT APPLICATION WITH THE MONOLITHIC SLIC

## TYPICAL COMPONENT VALUES

$\mathrm{C} 1=0.5 \mu \mathrm{~F}, 30 \mathrm{~V}$
RF1 $=$ RF2 $=210 k \Omega, 1 \%$
CF1 $=$ CF2 $=0.22 \mu F, 10 \%$, 20V Nonpolarized
C3 $=0.01 \mu \mathrm{~F}, 100 \mathrm{~V}, \pm 20 \%$
$\mathrm{C} 4=0.01 \mu \mathrm{~F}, 100 \mathrm{~V}, \pm 20 \%$
$\mathrm{C} 5=0.01 \mu \mathrm{~F}, 100 \mathrm{~V}, \pm 20 \%$
$\mathrm{C}_{\mathrm{AC}}=0.5 \mu \mathrm{~F}, 20 \mathrm{~V}$
$K Z_{0}=60 \mathrm{k} \Omega,\left(Z_{0}=600 \Omega, \mathrm{~K}=\right.$ Scaling Factor $\left.=100\right)$
RL1, RL2; Current Limit Setting Resistors:
RL1 + RL2 > 90k $\Omega \rightarrow$ offset
$\mathrm{I}_{\mathrm{LIMIT}}=(0.6)(R L 1+\mathrm{RL} 2) /(200 \times R L 2), R L 1$ typically $100 \mathrm{k} \Omega$

## NOTES:

1. All grounds ( $A G, B G$, \& $D G$ ) must be applied before $V_{B}+$ or $V_{B}$. Failure to do so may result in premature failure of the part. If a user wishes to run separate grounds off a line card, the AG must be applied first.
2. Application shows Ring Injected Ringing, a Balanced or Tip injected configuration may be used.

Additional information is contained in Application Note 549, "The HC-550X Telephone SLICs" By Geoff Phillips

